- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

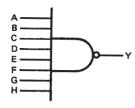
These devices contain a single 8-input NAND gate.

The SN5430, SN54LS30, and SN54S30 are characterized for operation over the full military range of  $-55\,^{\circ}\text{C}$  to  $125\,^{\circ}\text{C}$ . The SN7430, SN74LS30, and SN74S30 are characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ .

#### **FUNCTION TABLE**

OUTPUT Y
L H

#### logic diagram

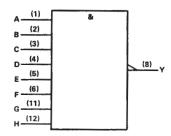


#### positive logic

$$Y = \overline{A \cdot B \cdot C \cdot D \cdot E \cdot F \cdot G \cdot H} \quad \text{or}$$

$$Y = \overline{A} + \overline{B} + \overline{C} + \overline{D} + \overline{E} + \overline{F} + \overline{G} + \overline{H}$$

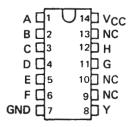
#### logic symbol†



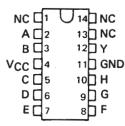
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

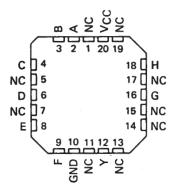
SN5430 . . . J PACKAGE
SN54LS30, SN54S30 . . . J OR W PACKAGE
SN7430 . . . N PACKAGE
SN74LS30, SN74S30 . . . D OR N PACKAGE
(TOP VIEW)



SN5430 . . . W PACKAGE (TOP VIEW)

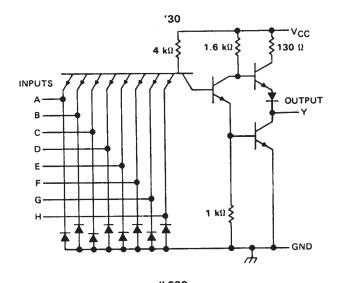


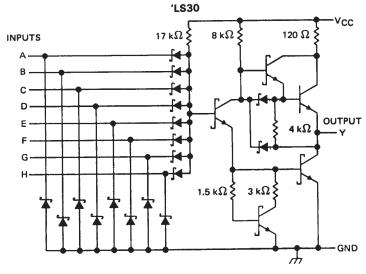
# SN54LS30, SN54S30 . . . FK PACKAGE (TOP VIEW)

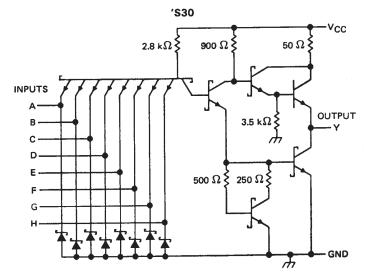


NC - No internal connection

#### schematics (each gate)







Resistor values shown are nominal.



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	 7 V
Input voltage	 5.5 V
Operating free-air temperature range: SN5430	 -55°C to 125°C
SN7430	 0°C to 70°C
Storage temperature range	 -65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			S	N5430			SN7430	0	
		MIN	V	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5	5.5	4.75	5	5.25	V
ViH	High-level input voltage		2			2			V
VIL	Low-level input voltage				8.0			0.8	<b>&gt;</b>
Іон	High-level output current				- 0.4			- 0.4	mA
IOL	Low-level output current				16			16	mA
TA	Operating free-air temperature	- 59	5		125	0		70	°c

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS †			SN5430			SN7430			
PARAMETER	TES	TEST CONDITIONS (		MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN, I <sub>I</sub> =	– 12 mA				- 1.5			1.5	V
Voн	V <sub>CC</sub> = MIN, V <sub>IL</sub>	= 0.8 V,	1 <sub>OH</sub> = − 0.4 mA	2.4	3.4		2.4	3.4		V
VOL	V <sub>CC</sub> = MIN, V <sub>I</sub>	4 = 2 V,	I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V
l <sub>1</sub>	V <sub>CC</sub> = MAX, V <sub>i</sub> =	= 5.5 V				1			1	mA
<sup>1</sup> ІН	V <sub>CC</sub> = MAX, V <sub>I</sub> =	= 2.4 V				40			40	μА
I <sub>IL</sub>	V <sub>CC</sub> = MAX, V <sub>I</sub> =	= 0.4 V				- 1.6			- 1.6	mA
I <sub>OS</sub> §	V <sub>CC</sub> = MAX			- 20		- 55	- 18		- 55	mA
Іссн	V <sub>CC</sub> = MAX, V <sub>I</sub> :	= 0			. 1	2		1	2	mA
1CCL	V <sub>CC</sub> = MAX, V <sub>I</sub>	= 4.5 V			3	6		3	6	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
tpLH					13	22	ns
tPHL	Any	Y	$R_L = 400 \Omega$ , $C_L = 15 pF$		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage		7 V
Operating free-air temperature range:	SN54LS30	55°C to 125°C
	SN74LS30	

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

			SN54LS	30	] :	SN74LS	30	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	ONII
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage	2	· · · · · · · · · · · · · · · · · · ·		2			٧
VIL	Low-level input voltage			0.7			8.0	٧
ЮН	High-level output current			- 0.4			- 0.4	mA
lOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN54LS	30		UNIT		
PARAMETER		TEST CONDITIONS †		MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	I <sub>1</sub> = - 18 mA				- 1.5			<b>– 1.5</b>	٧
Voн	V <sub>CC</sub> = MIN,	VIL = MAX,	I <sub>OH</sub> = - 0.4 mA	2.5	3.4		2.7	3.4		٧
	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 4 mA		0.25	0.4			0.4	
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	I <sub>OL</sub> = 8 mA					0.25	0.5	
. II	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mΑ
Чн	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				20			20	μА
IIL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 0.4			- 0.4	mA
I <sub>OS</sub> §	V <sub>CC</sub> = MAX			- 20		- 100	- 20		<b>– 100</b>	mA
Іссн	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0			0.35	0.5		0.35	0.5	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			0.6	1.1		0.6	1.1	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH .	Any	V	R <sub>L</sub> = 2 kΩ, C <sub>L</sub> = 15 pF		8	15	ns
t <sub>PHL</sub>	Ally	<b>'</b>	$R_L = 2 k\Omega$ , $C_L = 15 pF$		13	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ 

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54S30	-55°C to 125°C
SN74S30	
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN54S3	10		SN74S	30	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH High-level input voltage	2			2			٧
VIL Low-level input voltage			0.8			8.0	٧
IOH High-level output current			- 1			- 1	mA
IOL Low-level output current			20			20	mA
TA Operating free-air temperature	55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		SN54S30	SN74S30	UNIT
PARAMETER	TEST CONDITIONS †	MIN TYP‡ MAX	MIN TYP\$ MAX	ONT
VIK	V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA	-1.2	-1.2	٧
V <sub>OH</sub>	V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -1 mA	2.5 3.4	2.7 3.4	٧
VOL	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 20 mA	0.5	0.5	V
1,	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V	1	1	mA
Iн	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V	50	50	μΑ
IIL	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V	-2	-2	mA
IOS §	V <sub>CC</sub> = MAX	-40 -100	-40 -100	mA
Іссн	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0	3 5	3 5	mA
1CCL	V <sub>CC</sub> = MAX, V <sub>I</sub> = 4.5 V	5.5 10	5.5 10	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN TY	P MAX	UNIT
<sup>t</sup> PLH			D 290 O	CL = 15 pF		4 6	ns
<sup>t</sup> PHL			$R_L = 280 \Omega$ ,	C[ - 13 pi	4.	5 7	ns
<sup>t</sup> PLH	Any	l Y	R <sub>L</sub> = 280 Ω,	0 - 50 - 5	5.	5	ns
<sup>t</sup> PHL				C <sub>L</sub> = 50 pF	6.	5	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.





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### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9679201QCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Samples
5962-9679201QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
5962-9679201QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
JM38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
JM38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
M38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
M38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
M38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
M38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
M38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
M38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5430J	Samples
SN5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5430J	Samples
SN54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS30J	Sample
SN54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS30J	Samples
SN54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S30J	Samples
SN54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S30J	Samples
SN74LS30D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS30	Samples
SN74LS30NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS30	Samples
SNJ5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430J	Samples
SNJ5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430J	Samples
SNJ5430W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430W	Samples





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	<b>Device Marking</b> (4/5)	Samples
SNJ5430W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430W	Samples
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 30FK	Samples
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 30FK	Samples
SNJ54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30J	Samples
SNJ54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30J	Samples
SNJ54LS30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30W	Samples
SNJ54LS30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30W	Samples
SNJ54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Samples
SNJ54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Samples
SNJ54S30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
SNJ54S30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".





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RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS30, SN74LS30:

Catalog: SN74LS30

Military: SN54LS30

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

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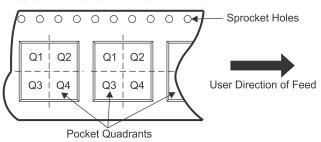
## TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Ī	Device		Package		SPQ	Reel	Reel	A0	B0	K0	P1	W	Pin1
		Туре	Drawing			Diameter (mm)	Width W1 (mm)	(mm)	(mm)	(mm)	(mm)	(mm)	Quadrant
	SN74LS30DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74LS30NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

## **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS30DR	SOIC	D	14	2500	853.0	449.0	35.0
SN74LS30NSR	SO	NS	14	2000	853.0	449.0	35.0

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



## D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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